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Reply under 37 CFR 1.116  
--Expedited Procedure--  
Technology Center 2800

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2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#7 Response  
1/17/03  
Amr

In re the Application of:

Lamson, et al. Docket No.: TI-28674  
Serial No.: 09/631,198 Examiner: Nguyen, Dilinh P  
Filed: 08/03/2000 Art Unit: 2814  
For: Structure and Method of High Performance Two Layer Ball Grid Array  
Substrate

Amendment under 37 CFR 1.116

Assistant Commissioner of Patents  
Washington, DC 20231

Dear Sir:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)  
I hereby certify that this correspondence is being deposited with the  
U.S. Postal Service as First Class Mail in an envelope addressed to:  
Assistant Commissioner for Patents, Washington, D.C. 20231 on

January 3, 2003

Elizabeth Austin

The following remarks are offered in response to the Examiner's Office Action dated 11/06/02. They are respectfully submitted as a full and complete response to that Action.

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